

1. Global joint venture starts operations as WeEn Semiconductors

Dear customer,

As from November 9th, 2015 NXP Semiconductors N.V. and Beijing JianGuang Asset Management Co. Ltd established Bipolar Power joint venture (JV), **WeEn Semiconductors**, which will be used in future Bipolar Power documents together with new contact details.

In this document where the previous NXP references remain, please use the new links as shown below.

WWW - For www.nxp.com use www.ween-semi.com

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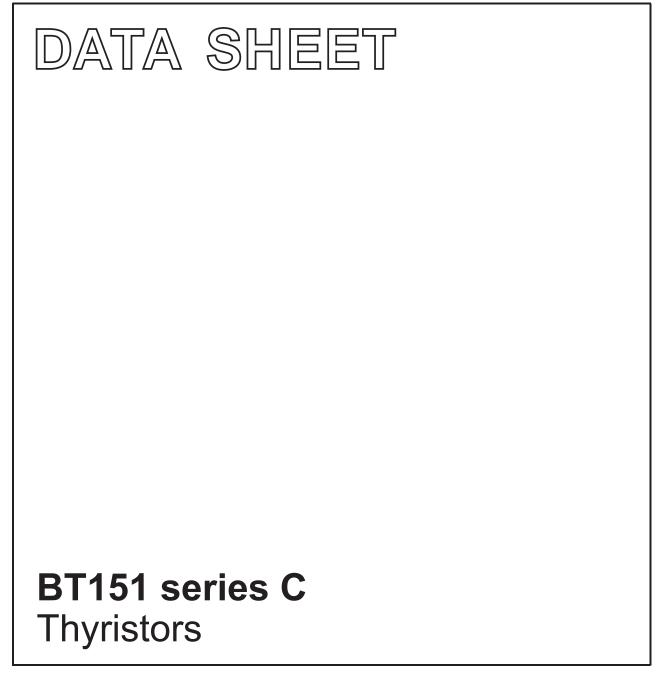
If you have any questions related to this document, please contact our nearest sales office via email or phone (details via <u>salesaddresses@ween-semi.com</u>).

Thank you for your cooperation and understanding,

WeEn Semiconductors



DISCRETE SEMICONDUCTORS



Product specification

April 2004



Product specification

BT151 series C

GENERAL DESCRIPTION

Passivated thyristors in a plastic envelope, intended for use in applications requiring high bidirectional blocking voltage capability and high thermal cycling performance. Typical applications include motor control, industrial and domestic lighting, heating and static switching.

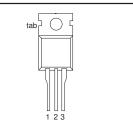
PINNING - TO220AB

PIN	DESCRIPTION			
1	cathode			
2	anode			
3	gate			
tab	anode			

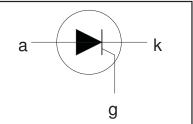
QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	MAX.	MAX.	UNIT
V _{drm} , V _{rrm} I _{t(av)} I _{t(rms)} I _{tsm}	BT151- Repetitive peak off-state voltages Average on-state current RMS on-state current Non-repetitive peak on-state current	500C 500 7.5 12 100	650C 650 7.5 12 100	800C 800 7.5 12 100	V A A A

PIN CONFIGURATION







LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 60134).

SYMBO L	PARAMETER	CONDITIONS	MIN.		MAX.		UNIT
V _{drm} , V _{rrm}	Repetitive peak off-state voltages		-	-500C 500 ¹	-650C 650 ¹	-800C 800	v
I _{T(AV)}	Average on-state current	half sine wave; $T_{mb} \le 109 ^{\circ}\text{C}$	-		7.5	1	A
I _{T(RMS)} I _{TSM}	RMS on-state current Non-repetitive peak on-state current	all conduction angles half sine wave; $T_j = 25 \degree C$ prior to surge	-		12		A
-2		t = 10 ms t = 8.3 ms	-		100 110		A A
l²t dl _⊤ /dt	I ² t for fusing Repetitive rate of rise of on-state current after	t = 10 ms I _{TM} = 20 A; I _G = 50 mA; dI _G /dt = 50 mA/μs	-		50 50		A²s A/μs
I _{GM} V _{GM} V _{RGM}	triggering Peak gate current Peak gate voltage Peak reverse gate		- - -		2 5 5		A V V
P _{GM} P _{G(AV)}	voltage Peak gate power Average gate power Storage temperature	over any 20 ms period	- - -40		5 0.5 150		W W °C
T _{stg} T _j	Operating junction temperature		-		125		°Č

¹ Although not recommended, off-state voltages up to 800V may be applied without damage, but the thyristor may switch to the on-state. The rate of rise of current should not exceed 15 A/ μ s.

BT151 series C

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R _{th j-mb}	Thermal resistance		-	-	1.3	K/W
R _{th j-a}	junction to mounting base Thermal resistance junction to ambient	in free air	-	60	-	K/W

STATIC CHARACTERISTICS

 $T_i = 25$ °C unless otherwise stated

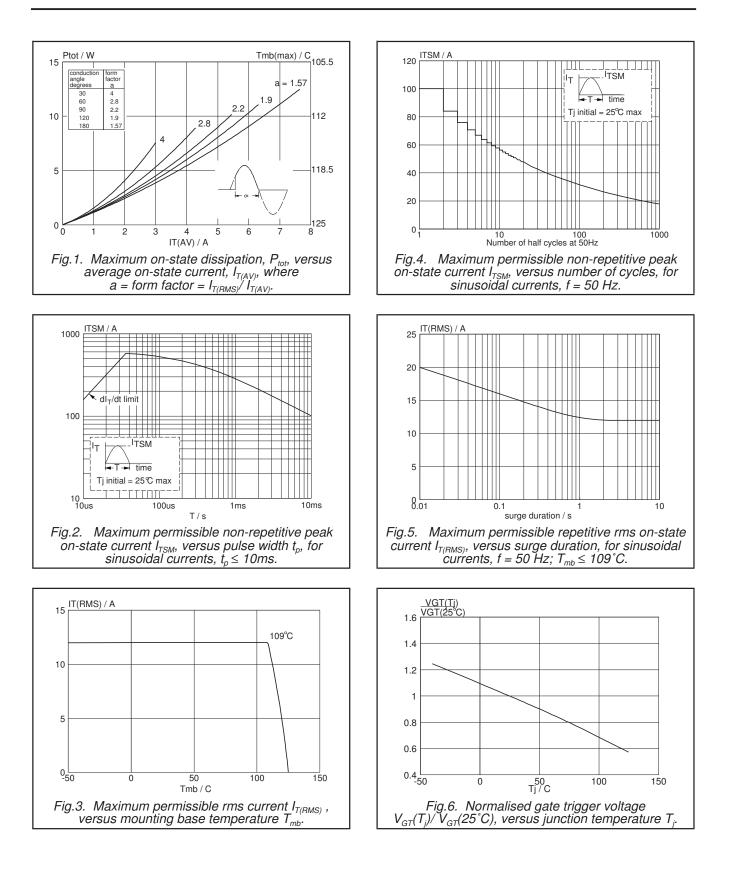
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{GT}	Gate trigger current	$V_{\rm D} = 12 \text{ V}; \text{ I}_{\rm T} = 0.1 \text{ A}$	-	2	15	mA
	Latching current	$V_{\rm D} = 12 \text{ V}; \text{ I}_{\rm GT} = 0.1 \text{ A}$	-	10	40	mA
I _H	Holding current	$V_{\rm D} = 12 \text{ V}; \text{ I}_{\rm GT} = 0.1 \text{ A}$	-	7	20	mA
V _T	On-state voltage	$I_{T} = 23 \text{ A}$	-	1.44	1.75	V
V _{GT}	Gate trigger voltage	$V_{\rm D} = 12 \text{ V}; \text{ I}_{\rm T} = 0.1 \text{ A}$	-	0.6	1.5	V
		$V_{\rm D} = V_{\rm DBM(max)}$: $I_{\rm T} = 0.1$ A: $T_{\rm i} = 125$ °C	0.25	0.4	-	V
I _D , I _R	Off-state leakage current	$V_D = V_{DRM(max)}^{DRM(max)}; V_R = V_{RRM(max)}; T_j = 125 °C$	-	0.1	0.5	mA

DYNAMIC CHARACTERISTICS

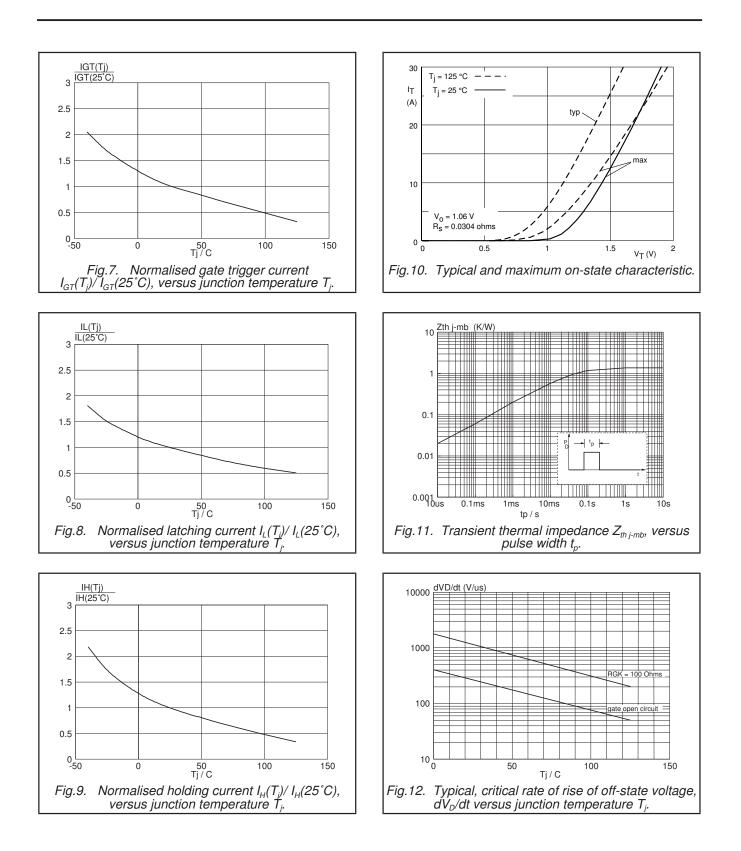
$T_i = 25$ °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
dV _D /dt t _{gt} t _q	Critical rate of rise of off-state voltage Gate controlled turn-on time Circuit commutated turn-off time	$ \begin{array}{l} V_{\text{DM}} = 67\% \; V_{\text{DRM}(\text{max})}; \; T_{j} = 125 \; ^{\circ}\text{C}; \\ \text{exponential waveform}; \\ & \text{Gate open circuit} \\ & R_{\text{GK}} = 100 \; \Omega \\ I_{\text{TM}} = 40 \; \text{A}; \; V_{\text{D}} = V_{\text{DRM}(\text{max})}; \; I_{\text{G}} = 0.1 \; \text{A}; \\ dI_{\text{G}}/dt = 5 \; \text{A}/\mu\text{s} \\ V_{\text{D}} = 67\% \; V_{\text{DRM}(\text{max})}; \; T_{j} = 125 \; ^{\circ}\text{C}; \\ I_{\text{TM}} = 20 \; \text{A}; \; V_{\text{R}} = 25 \; \text{V}; \; dI_{\text{TM}}/dt = 30 \; \text{A}/\mu\text{s}; \\ dV_{\text{D}}/dt = 50 \; \text{V}/\mu\text{s}; \; R_{\text{GK}} = 100 \; \Omega \end{array} $	50 200 - -	130 1000 2 70	- - -	V/μs V/μs μs μs

BT151 series C

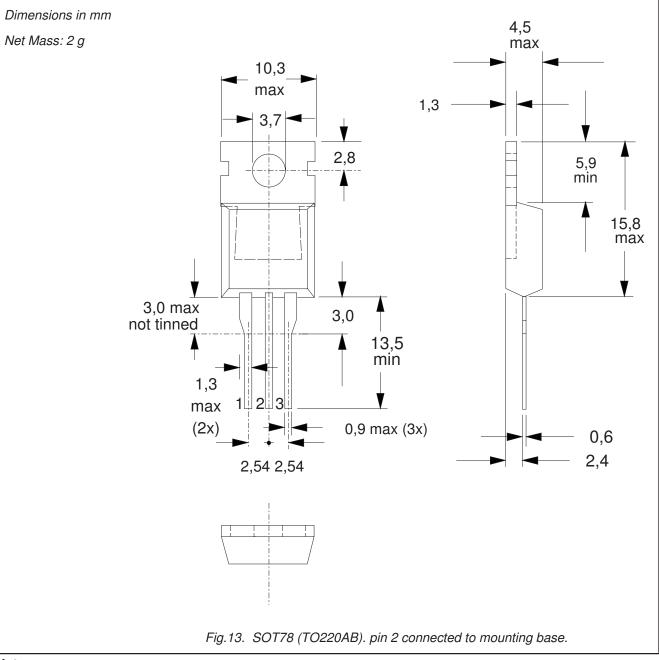


BT151 series C



BT151 series C

MECHANICAL DATA



Notes

Refer to mounting instructions for SOT78 (TO220) envelopes.
Epoxy meets UL94 V0 at 1/8".

Legal information

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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